

KSB772

Audio Frequency Power Amplifier

- Low Speed Switching
- WWW.BZSC.COM Complement to KSD882



PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units V	
V _{CBO}	Collector-Base Voltage	- 40		
V _{CEO}	Collector-Emitter Voltage	- 30	V	
V _{EBO}	Emitter-Base Voltage	- 5	V	
I _C	Collector Current (DC)	- 3	А	
I _{CP}	*Collector Current (Pulse)	- 7	Α	
I _B	Base Current (DC)	- 0.6	А	
P _C	Collector Dissipation (T _C =25°C)	10	W	
	Collector Dissipation (T _a =25°C)		W	
$R_{\theta ja}$	Junction to Ambient	132	°C/W	
R _{θja} R _{θjc} T _J	Junction to Case	13.5	°C/W	
T _J	Junction Temperature	150	°C	
T _{STG}	Storage Temperature	- 55 ~ 150	°C	

^{*} PW≤10ms, Duty Cycle≤50%

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
I _{CBO}	Collector Cut-off Current	$V_{CB} = -30V, I_{E} = 0$			- 1	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{EB} = -3V, I_{C} = 0$			- 1	μΑ
h _{FE1} h _{FE2}	* DC Current Gain	$V_{CE} = -2V, I_{C} = -20mA$ $V_{CE} = -2V, I_{C} = -1A$	30 60	220 160	400	30.00
V _{CE} (sat)	* Collector-Emitter Saturation Voltage	$I_C = -2A$, $I_B = -0.2A$		- 0.3	- 0.5	V
V _{BE} (sat)	* Base-Emitter Saturation Voltage	$I_C = -2A$, $I_B = -0.2A$		- 1.0	- 2.0	V
f _T	Current Gain Bandwidth Product	$V_{CE} = -5V, I_{E} = -0.1A$		80		MHz
C _{ob}	Output Capacitance	$V_{CB} = -10V, I_{E} = 0$ f = 1MHz		55		pF

^{*} Pulse Test: PW≤350μs, Duty Cycle≤2%

h_{FE} Classificntion

Classification	R	0	Y	G
h _{FE2}	60 ~ 120	100 ~ 200	160 ~ 320	200 ~ 400

Typical Characteristics

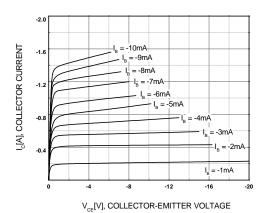


Figure 1. Static Characteristic

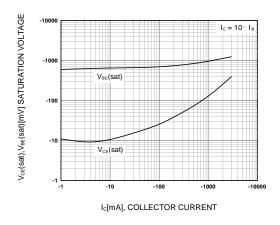


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

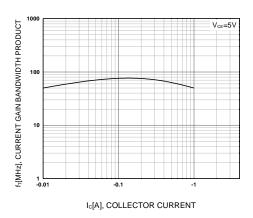


Figure 5. Current Gain Bandwidth Product

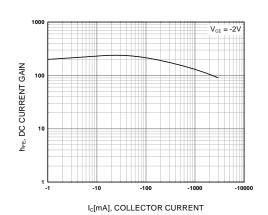


Figure 2. DC current Gain

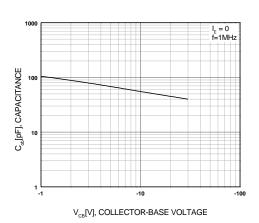


Figure 4. Collector Output Capacitance

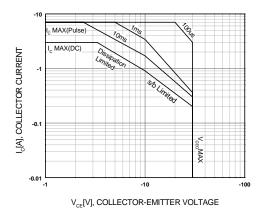


Figure 6. Safe Operating Area

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Typical Characteristics (Continued)

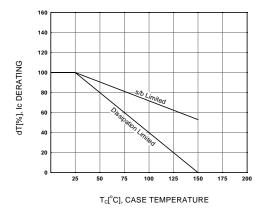


Figure 7. Derating Curve of Safe Operating Areas

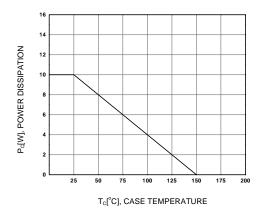
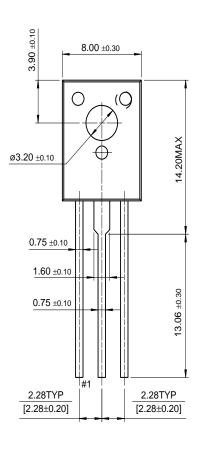
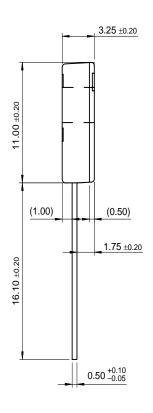


Figure 8. Power Derating

Package Dimensions

TO-126







Dimensions in Millimeters

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CoolFET™	FASTr™	MicroFET™	PowerTrench [®]	SuperSOT™-6
CROSSVOLT™	FRFET™	MicroPak™	QFET™	SuperSOT™-8
DOME™	GlobalOptoisolator™	MICROWIRE™	QS^{TM}	SyncFET™
EcoSPARK™	GTO™	MSX™	QT Optoelectronics™	TinyLogic™
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EnSigna™	I^2C^{TM}	OCX^{TM}	RapidConfigure™	UHC™ _
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Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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